

-30V P-Channel Enhancement Mode MOSFET
■ DESCRIPTION

The STP3401A is the P-Channel logic enhancement mode power field effect transistor is produced using high cell density advanced trench technology to provide excellent $R_{DS(ON)}$.low gate charge and operation gate as 2.5V.

This device is suitable for use as a load switch or other general applications.

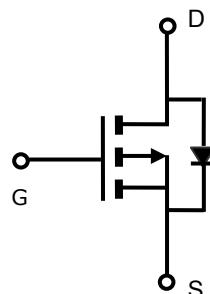
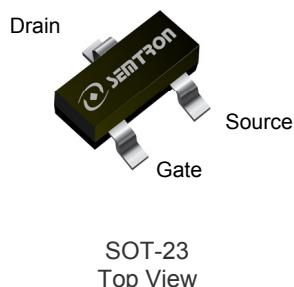
STP3401AS-TRG ROHS Compliant This is Halogen Free

■ FEATURE

- ◆ -30V/-4.3A, $R_{DS(ON)} = 50m\Omega$ (typ.)@ $V_{GS} = -10V$
- ◆ -30V/-3.5A, $R_{DS(ON)} = 58m\Omega$ (typ.)@ $V_{GS} = -4.5V$
- ◆ -30V/-2.5A, $R_{DS(ON)} = 73m\Omega$ (typ.)@ $V_{GS} = -2.5V$
- ◆ Super high density cell design for extremely low $R_{DS(ON)}$
- ◆ Exceptional on-resistance and Maximum DC current capability

■ APPLICATIONS

- ◆ High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- ◆ DC/DC Converter
- ◆ Load Switch


■ PIN CONFIGURATION

■ PART NUMBER INFORMATION

<u>ST</u> <u>P</u> <u>3401A</u> <u>S</u> - <u>TR</u> <u>G</u> a b c d e f	a : Company name. b : Channel type. c : Product Serial number. d : Package Code e : Handling Code f : Lead Plating Code G : Lead-free product. <i>This product is Halogen Free</i>
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■ ORDERING INFORMATION

Part Number	Package Code	Handling Code	Shipping
STP3401AS-TRG	S : SOT-23	TR : Tape&Reel	3K/Reel

※ Year Code : 0 ~ 9, 2010 : 0

※ Week Code : A(1~2) ~ Z(53~54)

※ SOT-23 : Only available in tape and reel packaging.

■ ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ Unless otherwise noted)

Symbol	Parameter		Typical	Unit
V_{DSS}	Drain-Source Voltage		-30	V
V_{GSS}	Gate-Source Voltage		± 12	V
I_D	Continuous Drain Current ($T_c=25^\circ C$) ^A	$V_{GS}=-12V$	-4.3	A
	Continuous Drain Current ($T_c=70^\circ C$) ^A		-3.8	A
I_{DM}	Pulsed Drain Current ^B		-20	A
P_D	Power Dissipation	$T_A=25^\circ C$ $T_A=70^\circ C$	1.25 0.8	W
T_J	Operation Junction Temperature		-55 to 150	$^\circ C$
T_{STG}	Storage Temperature Range		-55 to 150	$^\circ C$

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL DATA

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient ^A	Steady-State	-	$^\circ C/W$
$R_{\theta JL}$	Thermal Resistance Junction to Lead ^A	Steady-State	-	$^\circ C/W$

ELECTRICAL CHARACTERISTICS($T_J = 25^\circ C$ Unless otherwise noted)

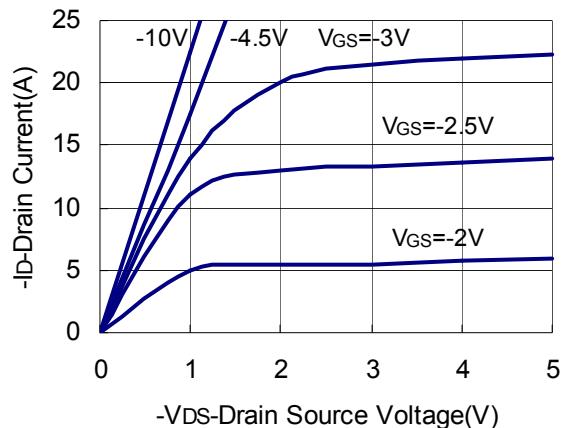
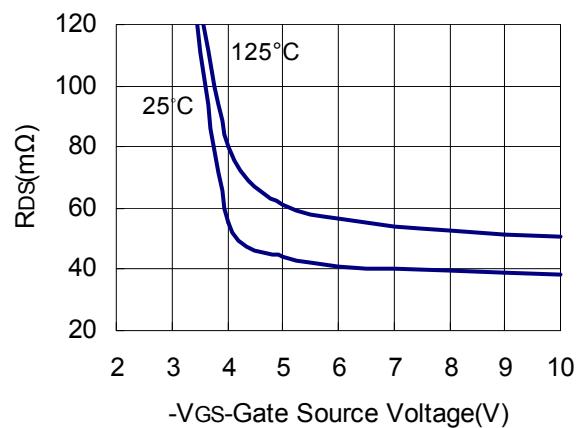
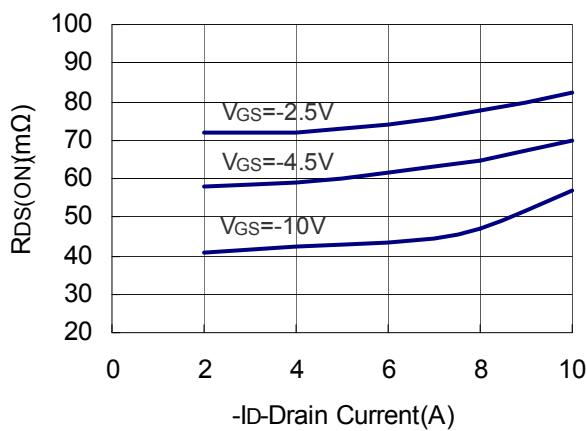
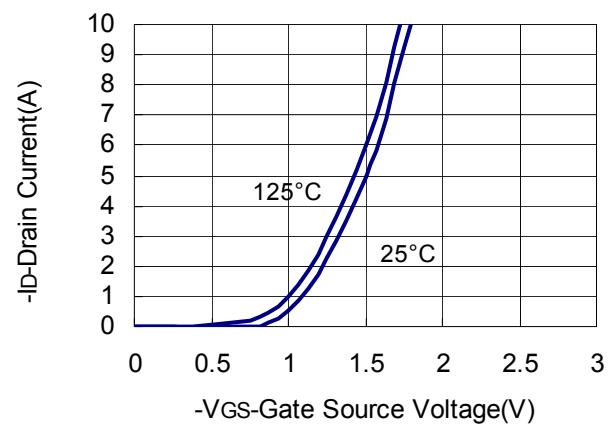
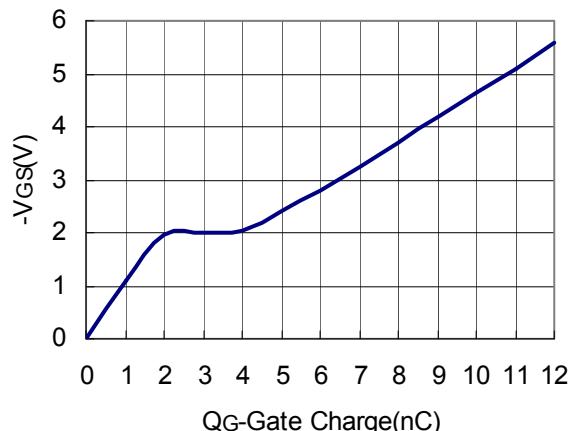
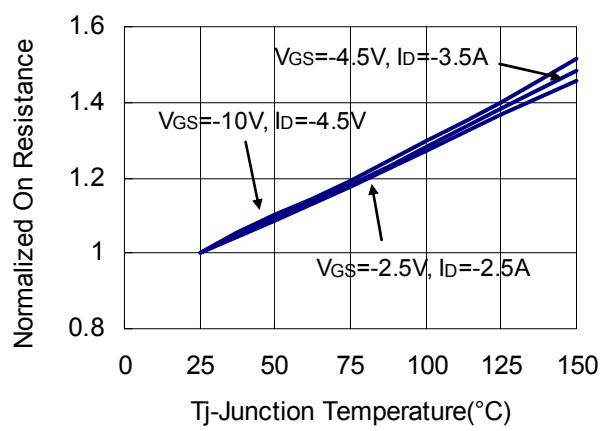
Symbol	Parameter	Condition	Min	Typ	Max	Unit	
Static Parameters							
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-30			V	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.6		-1.0	V	
I_{GSS}	Gate Leakage Current	$V_{DS}=0V, V_{GS}=\pm 12V$			± 100	nA	
I_{DSS}	Zero Gate Voltage, Drain-Source Leakage Current	$V_{DS}=-24V, V_{GS}=0V$ $T_J=25^\circ C$			-1	μA	
		$V_{DS}=-24V, V_{GS}=0V$ $T_J=55^\circ C$			-5		
$R_{DS(ON)}$	Drain-source On-Resistance ^B	$V_{GS}=-10V, I_D=-4.3A$		50	56	$m\Omega$	
		$V_{GS}=-4.5V, I_D=-3.5A$		58	65		
		$V_{GS}=-2.5V, I_D=-2.5A$		73	80		
G_{fs}	Forward Transconductance	$V_{DS}=-5V, I_D=-4.0A$		10		S	
Source-Drain Diode							
V_{SD}	Diode Forward Voltage	$I_S=-1.0A, V_{GS}=0V$		-0.7	-1.0	V	
I_S	Continuous Source Current ^{AD}				-5.6	A	
Dynamic Parameters							
$Q_g (-4.5V)$	Total Gate Charge	$V_{DS}=-20V$ $V_{GS}=-4.5V$ $I_D=-4.0A$		6.8		nC	
Q_{gs}	Gate-Source Charge			3.0			
Q_{gd}	Gate-Drain Charge			3.3			
C_{iss}	Input Capacitance	$V_{DS}=-12V$ $V_{GS}=0V$ $f=1MHz$		681		pF	
C_{oss}	Output Capacitance			290			
C_{rss}	Reverse Transfer Capacitance			112			
$t_{d(on)}$	Turn-On Time	$V_{DD}=-12V$ $I_D=-4A$ $V_{GEN}=-10V$ $R_G=3.3\Omega$		10		nS	
t_r				16			
$t_{d(off)}$	Turn-Off Time			24			
t_f				22			

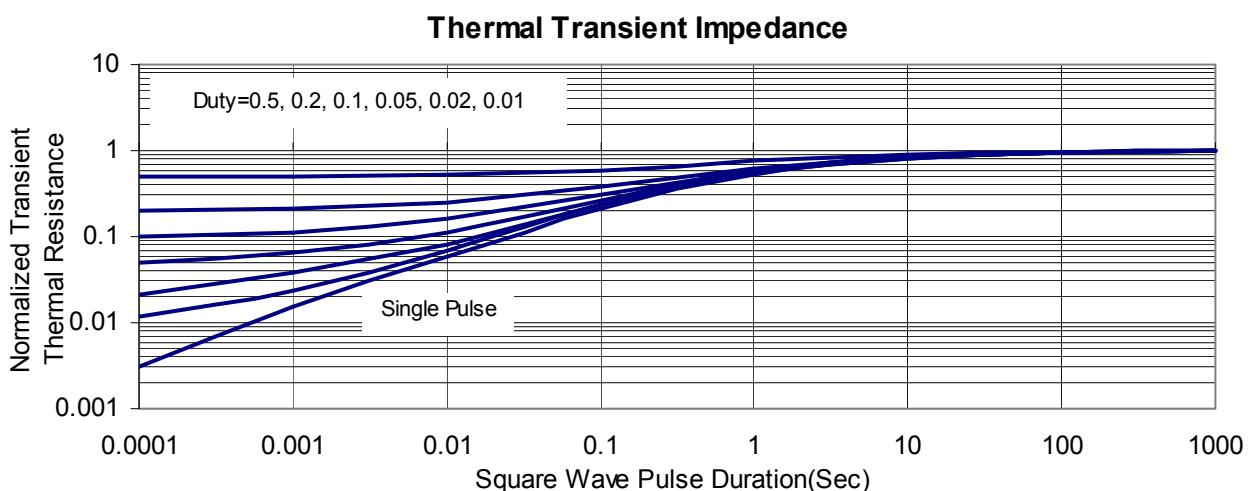
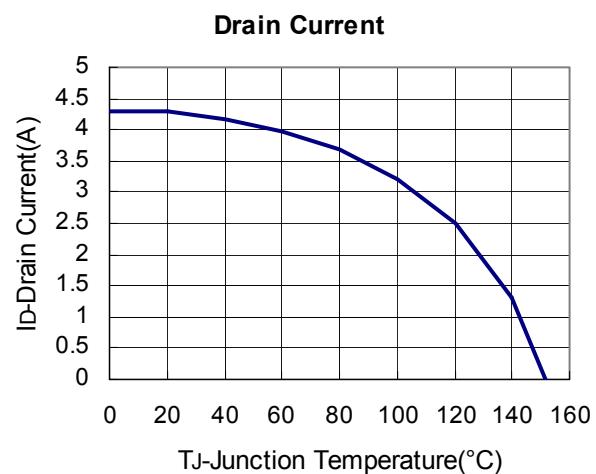
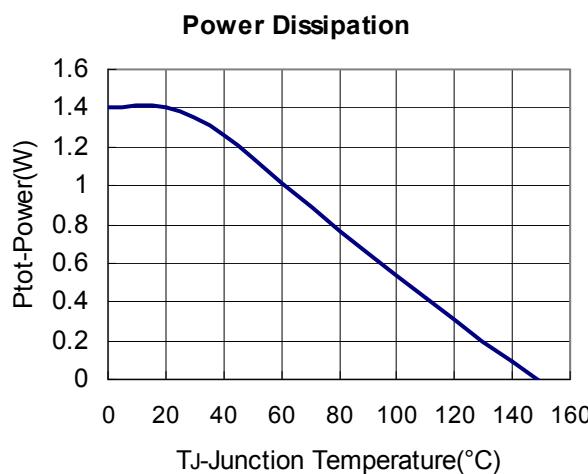
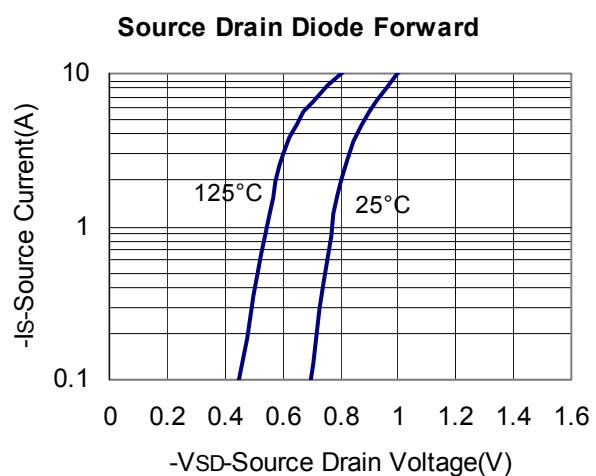
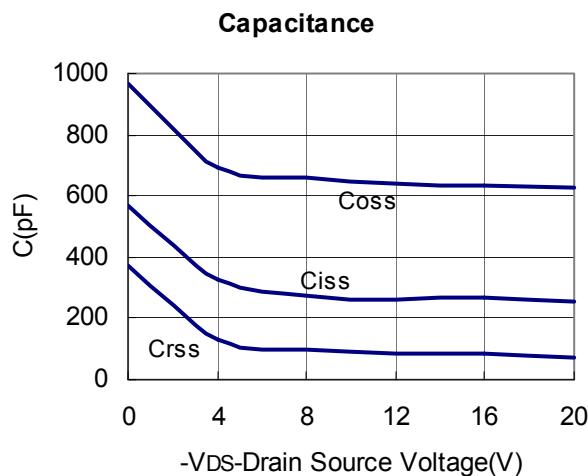
Note:

- A. The value of $R_{DS(on)}$ is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ C$.
- B. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
- C. The EAS data shows Max. rating . The test condition is $V_{DD}=-25V, V_{GS}=-10V, L=0.1mH$.
- D. The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

The products and product specifications contained herein are subject to change without notice to improve performance characteristics. Consult us, or our representatives before use, to confirm that the information in this datasheet is up to date

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TYPICAL CHARACTERISTICS (25°C Unless Note)
Output Characteristics

Drain-Source On Resistance

Drain Source On Resistance

Transfer Characteristics

Gate Charge

Drain Source Resistance


TYPICAL CHARACTERISTICS (25°C Unless Note)


SOT-23 PACKAGE DIMENSIONS

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L1	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

